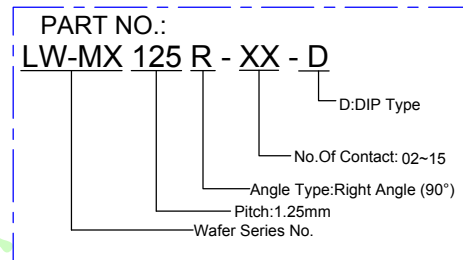


MATERIAL:

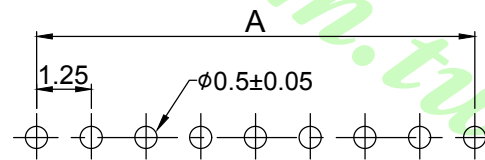
Wafer: Nylon46, UL94V-0.
Pin: High Strength, Brass
With Tin over Nickel plated

SPECIFICATION:

Current Rating: 1A AC, DC
Voltage Rating: 125V AC,DC
Operating Temp.: -40°C ~ +85°C
Insulation Resistance: 100MΩ/ min.
Dielectric Withstanding Voltage: 250V AC/ minute
Contact Resistance: 20mΩ/ max.



CKT.	Dimension mm		
	A	B	C
2	1.25	3.15	4.25
3	2.50	4.40	5.50
4	3.75	5.65	6.75
5	5.00	6.90	8.00
6	6.25	8.15	9.25
7	7.50	9.40	10.50
8	8.75	10.66	11.75
9	10.00	11.90	13.00
10	11.25	13.15	14.25
11	12.50	14.40	15.50
12	13.75	15.65	16.75
13	15.00	16.90	18.00
14	16.25	18.15	19.25
15	17.50	19.40	20.50



RECOMMENDED PC BOARD HOLE DIMM.

LOCKING WINDOW:
ONE PLACE FOR 2 AND 3 CKT.
AND TWO PLACES FOR MORE THAN 3 CKT.

			公差/UNLESS OTHERWISE SPECIFIED TOLERANCES ARE	單位/Unit mm	品名(Title):
A0	NEW DRAWING	2018.08.16	X.XX ±0.15 X.X ±0.25	比例/Scale Free	WIRE TO BOARD 1.25mm WAFER DIP 90°
REV	概述/REVISION	日期/DATE		料號/Part No:	圖號/Drawing No:

鍊亨電子有限公司
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核對/APPD. Joe 審核/CHKD. Joe 製圖/DR. Mandy 張數/Sheet 1 of 1

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